



Claim Chart for References Submitted in 2nd Information Disclosure Statement for 10/766,488

Claim Chart for Claim 61 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, a fiber optic module comprising a laser diode module to convert a laser diode electric signal to a laser diode optical signal. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board to a laser diode electric signal for a laser diode. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, a fiber optic module comprising a laser diode module to convert a laser diode electric signal to a laser diode optical signal. |
| A6 | USP4,911,519 | A6 does not disclose, at least, a fiber optic module comprising a circuit board to carry thereon a connector, a laser diode driver, a laser diode module and a photo diode module. |
| A7 | USP4,912,521 | A7 through A8 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board to a laser diode electric signal for a laser diode. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, a fiber optic module comprising a laser diode module to convert a laser diode electric signal to a laser diode optical signal. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, a fiber optic module comprising a circuit board to carry thereon a connector, a laser diode driver, a laser diode module and a photo diode module. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board to a laser diode electric signal for a laser diode. |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board to a laser diode electric signal for a laser diode. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, a fiber optic module comprising a laser diode module to convert a laser diode electric signal to a laser diode optical signal. |
| B4 | USP5,280,191 | |

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|-----|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B5 | USP5,289,345 | B5 does not disclose, at least, a fiber optic module comprising a circuit board to carry thereon a connector, a laser diode driver, a laser diode module and a photo diode module. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board to a laser diode electric signal for a laser diode. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 through B13 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board to a laser diode electric signal for a laser diode. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board to a laser diode electric signal for a laser diode. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, a fiber optic module comprising a laser diode module to convert a laser diode electric signal to a laser diode optical signal. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board to a laser diode electric signal for a laser diode. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants |

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| C10 | JP7-225327 | have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, a fiber optic module comprising a laser diode module to convert a laser diode electric signal to a laser diode optical signal. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board to a laser diode electric signal for a laser diode. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, a fiber optic module comprising a laser diode module to convert a laser diode electric signal to a laser diode optical signal. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board to a laser diode electric signal for a laser diode. |

Claim Chart for Claims 62-65 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, a fiber optic module comprising a laser diode module including a laser diode, to convert a laser diode electric signal to a laser diode optical signal, said laser diode optical signal adapted for transmission to an optical fiber connected with said laser diode module, said laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board through a connector to a laser diode electric signal for a laser diode. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, a fiber optic module comprising a laser diode module including a laser diode, to convert a laser diode electric signal to a laser diode optical signal, said laser diode optical signal adapted for transmission to an optical fiber connected with said laser diode module, said laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| A6 | USP4,911,519 | A6 does not disclose, at least, a fiber optic module comprising a circuit board to carry thereon a connector, a laser diode driver, a laser diode module, a photo diode module and a semiconductor integrated circuit. |
| A7 | USP4,912,521 | A7 through A8 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board through a connector to a laser diode electric signal for a laser diode. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, a fiber optic module comprising a laser diode module including a laser diode, to convert a laser diode electric signal to a laser diode optical signal, said laser diode optical signal adapted for transmission to an optical fiber connected with said laser diode module, said laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, a fiber optic module comprising a circuit board to carry thereon a connector, a laser diode driver, a laser diode |
| A11 | USP4,979,787 | |

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| | | module, a photo diode module and a semiconductor integrated circuit. |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board through a connector to a laser diode electric signal for a laser diode. |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board through a connector to a laser diode electric signal for a laser diode. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, a fiber optic module comprising a laser diode module including a laser diode, to convert a laser diode electric signal to a laser diode optical signal, said laser diode optical signal adapted for transmission to an optical fiber connected with said laser diode module, said laser diode optical signal having a data transmission rate of 1000 Mbits/s or more |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, a fiber optic module comprising a circuit board to carry thereon a connector, a laser diode driver, a laser diode module, a photo diode module and a semiconductor integrated circuit. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board through a connector to a laser diode electric signal for a laser diode. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board through a connector to a laser diode electric signal for a laser diode. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, |

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| | | 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board to a laser diode electric signal for a laser diode. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, a fiber optic module comprising a laser diode module including a laser diode, to convert a laser diode electric signal to a laser diode optical signal, said laser diode optical signal adapted for transmission to an optical fiber connected with said laser diode module, said laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board through a connector to a laser diode electric signal for a laser diode. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, a fiber optic module comprising a laser diode module including a laser diode, to convert a laser diode electric signal to a laser diode optical signal, said laser diode optical signal adapted for transmission to an optical fiber connected with said laser diode module, said laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board through a connector to a laser diode electric signal for a laser diode. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, a fiber optic module comprising a laser diode module including a laser diode, to convert a laser diode electric signal to a laser diode optical signal, said laser diode optical signal adapted for transmission to an optical fiber connected with said laser diode module, said laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, a fiber optic module comprising a laser diode driver to convert serial data received from a mother board through a connector to a laser diode electric signal for a laser diode. |

Claim Chart for Claims 69-105 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, a fiber optic module comprising a laser diode module having an opening adapted for insertion of one of at least one optical fiber, said laser diode module adapted to output a laser diode optical signal to the at least one optical fiber. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, a fiber optic module comprising a laser diode driver to drive a laser diode module according to serial data received from a computer through a connector. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, a fiber optic module comprising a laser diode module having an opening adapted for insertion of one of at least one optical fiber, said laser diode module adapted to output a laser diode optical signal to the at least one optical fiber. |
| A6 | USP4,911,519 | A6 does not disclose, at least, a fiber optic module comprising a sole circuit board to mount thereon a connector, a laser diode module, a laser diode driver, and a photo diode module. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, a fiber optic module comprising a laser diode driver to drive a laser diode module according to serial data received from a computer through a connector. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, a fiber optic module comprising a laser diode module having an opening adapted for insertion of one of at least one optical fiber, said laser diode module adapted to output a laser diode optical signal to the at least one optical fiber. |
| A10 | USP4,969,924 | A10 and A11 not disclose, at least, a fiber optic module comprising a sole circuit board to mount thereon a connector, a laser diode module, a laser diode driver, and a photo diode module. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, a fiber optic module comprising a laser diode driver to drive a laser diode module according to serial data received from a computer through a connector. |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|----------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, a fiber optic |

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| B2 | USP5,202,943 | module comprising a laser diode driver to drive a laser diode module according to serial data received from a computer through a connector. |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, a fiber optic module comprising a laser diode module having an opening adapted for insertion of one of at least one optical fiber, said laser diode module adapted to output a laser diode optical signal to the at least one optical fiber. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, a fiber optic module comprising a sole circuit board to mount thereon a connector, a laser diode module, a laser diode driver, and a photo diode module. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, a fiber optic module comprising a laser diode driver to drive a laser diode module according to serial data received from a computer through a connector. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, a fiber optic module comprising a laser diode driver to drive a laser diode module according to serial data received from a computer through a connector. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, a fiber optic module comprising a laser diode module having an opening adapted for insertion of one of at least one optical fiber, said laser diode module adapted to output a laser diode optical signal to the at least one optical fiber. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, a fiber optic module comprising a laser diode module having an opening adapted for insertion of one of at least one |
| C2 | USP4,727,248 | |

| | | |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | optical fiber, said laser diode module adapted to output a laser diode optical signal to the at least one optical fiber. |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, a fiber optic module comprising a laser diode driver to drive a laser diode module according to serial data received from a computer through a connector. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, a fiber optic module comprising a laser diode module having an opening adapted for insertion of one of at least one optical fiber, said laser diode module adapted to output a laser diode optical signal to the at least one optical fiber. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, a fiber optic module comprising a laser diode module having an opening adapted for insertion of one of at least one optical fiber. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, a fiber optic module comprising a laser diode module having an opening adapted for insertion of one of at least one optical fiber, said laser diode module adapted to output a laser diode optical signal to the at least one optical fiber. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, a fiber optic module comprising a laser diode driver to drive a laser diode module according to serial data received from a computer through a connector. |

Claim Chart for Claims 106-121 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000Mbits/s or more. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a mother board, into a laser diode electrical signal. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000Mbits/s or more. |
| A6 | USP4,911,519 | A6 does not disclose, at least, an optical module comprising a single circuit board, on which a serial connector and a laser diode electrical signal converter are mounted and to which a laser diode and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a mother board, into a laser diode electrical signal. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000Mbits/s or more. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, an optical module comprising a single circuit board, on which a serial connector and a laser diode electrical signal converter are mounted and to which a laser diode and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |

| | | |
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| A15 | USP5,099,307 | from a mother board, into a laser diode electrical signal. |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a mother board, into a laser diode electrical signal. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000Mbits/s or more. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, an optical module comprising a single circuit board, on which a serial connector and a laser diode electrical signal converter are mounted and to which a laser diode and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a mother board, into a laser diode electrical signal. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a mother board, into a laser diode electrical signal. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000Mbits/s or more. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. |

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| | Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
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| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000Mbits/s or more. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a mother board, into a laser diode electrical signal. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000Mbits/s or more. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, an optical module comprising a laser diode module and a photo diode module being electrically connected to a circuit board proximate to a first edge of the circuit board that is opposite a second edge of the circuit board, which a serial connector is positioned proximate to. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical |
| D6 | IBM Opto-Electronics Enterprise, RCL- | |

| | | |
|----|----------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | 2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | signal, which is transmitted at a data transmission rate of 1000Mbits/s or more. |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, an optical module comprising a serial connector being positioned proximate to a second edge of a circuit board that is opposite a first edge of the circuit board, which a laser diode module and a photo diode module are electrically connected to the circuit board proximate to. |

Claim Chart for Claims 122-127 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 through A16 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that foreign matter is prevented from invading into a first opening of the laser diode module and a second opening of the photo diode module when the module cap is removably attached to an optical module. |
| A2 | USP4,553,813 | |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | |
| A6 | USP4,911,519 | |
| A7 | USP4,912,521 | |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | |
| A10 | USP4,969,924 | |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 through B10 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that foreign matter is prevented from invading into a first opening of the laser diode module and a second opening of the photo diode module when the module cap is removably attached to an optical module. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | |
| B6 | USP5,325,454 | |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that foreign matter is prevented from invading into a first opening of the laser diode module and a second opening of the photo diode module when the module cap is removably attached to an optical module. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. |

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|-----|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that foreign matter is prevented from invading into a first opening of the laser diode module and a second opening of the photo diode module when the module cap is removably attached to an optical module. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that foreign matter is prevented from invading into a first opening of the laser diode module and a second opening of the photo diode module when the module cap is removably attached to an optical module. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that foreign matter is prevented from invading into a first opening of the laser diode module and a second opening of the photo diode module when the module cap is removably attached to an optical module. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

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| | | prevented from invading into a first opening of the laser diode module and a second opening of the photo diode module when the module cap is removably attached to an optical module. |
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| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D8 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that foreign matter is prevented from invading into a first opening of the laser diode module and a second opening of the photo diode module when the module cap is removably attached to an optical module. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | |

Claim Chart for Claims 128-138 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, an optical module comprising a laser diode module including a laser diode, to convert a laser diode electrical signal into a laser diode optical signal, which adapted for transmission to an optical fiber the laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, an optical module comprising a laser diode driver to convert serial data received through a surface mount type connector to a laser diode electrical signal for a laser diode. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, an optical module comprising a laser diode module including a laser diode, to convert a laser diode electrical signal into a laser diode optical signal, which adapted for transmission to an optical fiber the laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| A6 | USP4,911,519 | A6 does not disclose, at least, an optical module comprising a sole circuit board to mount thereon a surface mount type connector, a laser diode driver, a laser diode module, a photo diode module and a semiconductor integrated circuit. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, an optical module comprising a laser diode driver to convert serial data received through a surface mount type connector to a laser diode electrical signal for a laser diode. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, an optical module comprising a laser diode module including a laser diode, to convert a laser diode electrical signal into a laser diode optical signal, which adapted for transmission to an optical fiber the laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, an optical module comprising a sole circuit board to mount thereon a surface mount type connector, a laser diode driver, a laser diode module, a photo diode module and a semiconductor integrated circuit. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, an optical module comprising a laser diode driver to |
| A13 | USP5,039,194 | |

| | | |
|-----|--------------|---------------------------------------------------------------------------------------------------------------------------|
| A14 | USP5,047,835 | convert serial data received through a surface mount type connector to a laser diode electrical signal for a laser diode. |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, an optical module comprising a laser diode driver to convert serial data received through a surface mount type connector to a laser diode electrical signal for a laser diode. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, an optical module comprising a laser diode module including a laser diode, to convert a laser diode electrical signal into a laser diode optical signal, which adapted for transmission to an optical fiber the laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, an optical module comprising a sole circuit board to mount thereon a surface mount type connector, a laser diode driver, a laser diode module, a photo diode module and a semiconductor integrated circuit. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, an optical module comprising a laser diode driver to convert serial data received through a surface mount type connector to a laser diode electrical signal for a laser diode. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 through B13 do not disclose, at least, an optical module comprising a laser diode driver to convert serial data received through a surface mount type connector to a laser diode electrical signal for a laser diode. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, an optical module comprising a laser diode module including a laser diode, to convert a laser diode electrical signal into a laser diode optical signal, which adapted for transmission to an optical fiber the laser diode |

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| | | optical signal having a data transmission rate of 1000 Mbits/s or more. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, an optical module comprising a laser diode module including a laser diode, to convert a laser diode electrical signal into a laser diode optical signal, which adapted for transmission to an optical fiber the laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, an optical module comprising a laser diode driver to convert serial data received through a surface mount type connector to a laser diode electrical signal for a laser diode. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, an optical module comprising a laser diode module including said laser diode, to convert said laser diode electrical signal into a laser diode optical signal, said laser diode optical signal adapted for transmission to an optical fiber said laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, an optical module comprising a laser diode driver to convert serial data received through a surface mount type connector to a laser diode electrical signal for a laser diode. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, an optical module comprising a laser diode module including a laser diode, to convert a laser diode electrical signal into a laser diode optical signal, which adapted for transmission to an optical fiber the laser diode optical signal having a data transmission rate of 1000 Mbits/s or more. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, an optical module comprising a laser diode driver to convert serial data received through a surface mount type connector to a laser diode electrical signal for a laser diode. |

Claim Chart for Claims 139-157 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, which a serial connector transfers, into a laser diode electrical signal. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A6 | USP4,911,519 | A6 does not disclose, at least, an optical module comprising a single circuit board, on which a laser diode electrical signal converter are mounted and to which a laser diode module and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, which a serial connector transfers, into a laser diode electrical signal. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, an optical module comprising a single circuit board, on which a laser diode electrical signal converter are mounted and to which a laser diode module and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, which a serial connector transfers, into a laser diode electrical signal. |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, an optical |

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| B2 | USP5,202,943 | module comprising a laser diode electrical signal converter to convert serial data, which a serial connector transfers, into a laser diode electrical signal. |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, an optical module comprising a single circuit board, on which a laser diode electrical signal converter are mounted and to which a laser diode module and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, which a serial connector transfers, into a laser diode electrical signal. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, which a serial connector transfers, into a laser diode electrical signal. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|---------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, an optical module comprising a laser diode module to convert |
| C2 | USP4,727,248 | |

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|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, which a serial connector transfers, into a laser diode electrical signal. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, an optical module comprising a laser diode module and a photo diode module being electrically connected to a circuit board proximate to a first edge of the circuit board that is opposite a second edge of the circuit board, which a serial connector is positioned proximate to. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, a serial connector being positioned proximate to a second edge of a circuit board that is opposite a first edge of the |

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| | | circuit board, which a laser diode module and a photo diode module are electrically connected to the circuit board proximate to. |
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Claim Chart for Claims 158 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 through A16 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, and being removably attachable to an optical module. |
| A2 | USP4,553,813 | |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | |
| A6 | USP4,911,519 | |
| A7 | USP4,912,521 | |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | |
| A10 | USP4,969,924 | |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 through B10 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, and being removably attachable to an optical module. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | |
| B6 | USP5,325,454 | |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, and being removably attachable to an optical module. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

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|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B15 | USP5,550,941 | B15 does not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, and being removably attachable to an optical module. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, and being removably attachable to an optical module. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, and being removably attachable to an optical module. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D8 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, and being removably attachable to an optical module. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | |

Claim Chart for Claims 159-162 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 through A16 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that the first elastic part and the second elastic part protect the laser diode module and the photo diode module from foreign matter when the module cap is removably attached to an optical module. |
| A2 | USP4,553,813 | |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | |
| A6 | USP4,911,519 | |
| A7 | USP4,912,521 | |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | |
| A10 | USP4,969,924 | |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 through B10 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that the first elastic part and the second elastic part protect the laser diode module and the photo diode module from foreign matter when the module cap is removably attached to an optical module. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | |
| B6 | USP5,325,454 | |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that the first elastic part and the second elastic part protect the laser diode module and the photo diode module from foreign matter when the module cap is removably attached to an optical module. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. |

| | | |
|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that the first elastic part and the second elastic part protect the laser diode module and the photo diode module from foreign matter when the module cap is removably attached to an optical module. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that the first elastic part and the second elastic part protect the laser diode module and the photo diode module from foreign matter when the module cap is removably attached to an optical module. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that the first elastic part and the second elastic part protect the laser diode module and the photo diode module from foreign matter when the module cap is removably attached to an optical module. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D8 do not disclose, at least, a module cap comprising a first elastic part to protect a laser diode module and a second elastic part to protect a photo diode module, such that the first elastic part and the second elastic part protect the laser diode module and the photo diode module from foreign matter when the module cap is removably attached to an optical module. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | |

Claim Chart for Claims 163-165 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, an optical module comprising a laser diode driver to covert serial data, which a serial connector transfers, into a laser diode electrical signal and to drive a laser diode according to the laser diode electrical signal, producing a laser diode optical signal such that the laser diode transmits the laser diode optical signal. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, an optical module comprising a serial connector to transfer serial data. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, an optical module comprising a laser diode driver to covert serial data, which a serial connector transfers, into a laser diode electrical signal and to drive a laser diode according to the laser diode electrical signal, producing a laser diode optical signal such that the laser diode transmits the laser diode optical signal. |
| A6 | USP4,911,519 | A6 does not disclose, at least, an optical module comprising a single circuit board, on which a serial connector and a laser diode electrical signal converter are mounted and to which a laser diode and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, an optical module comprising a serial connector to transfer serial data. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, an optical module comprising a laser diode driver to covert serial data, which a serial connector transfers, into a laser diode electrical signal and to drive a laser diode according to the laser diode electrical signal, producing a laser diode optical signal such that the laser diode transmits the laser diode optical signal. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, an optical module comprising a single circuit board, on which a serial connector and a laser diode electrical signal converter are mounted and to which a laser diode and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, an optical module comprising a serial connector to |
| A13 | USP5,039,194 | |

| | | |
|-----|--------------|-----------------------|
| A14 | USP5,047,835 | transfer serial data. |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, an optical module comprising a serial connector to transfer serial data. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, an optical module comprising a laser diode driver to covert serial data, which a serial connector transfers, into a laser diode electrical signal and to drive a laser diode according to the laser diode electrical signal, producing a laser diode optical signal such that the laser diode transmits the laser diode optical signal. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, an optical module comprising a single circuit board, on which a serial connector and a laser diode electrical signal converter are mounted and to which a laser diode and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, an optical module comprising a serial connector to transfer serial data. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, an optical module comprising a serial connector to transfer serial data. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclosed, at least, an optical module comprising a laser diode. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan.. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, an optical module comprising a laser diode driver to covert serial data, which a serial connector transfers, into a laser diode electrical signal and to drive a laser diode according to the laser diode electrical signal, producing a laser diode optical signal such that the laser diode transmits the laser diode optical signal. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, an optical module comprising a serial connector to transfer serial data. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, an optical module comprising a laser diode driver to covert serial data, which a serial connector transfers, into a laser diode electrical signal and to drive a laser diode according to the laser diode electrical signal, producing a laser diode optical signal such that the laser diode transmits the laser diode optical signal. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, an optical module comprising a laser diode and a photo diode module electrically connected to a circuit board proximate to a first edge of the circuit board that is opposite a second edge of the circuit board, which a serial connector is positioned proximate to and in parallel with. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, an optical module comprising a laser diode driver to covert serial data, which a serial connector transfers, into a laser diode electrical signal and to drive a laser diode according to the laser diode electrical signal, producing a laser diode optical signal such that the laser diode transmits the laser diode optical signal. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, a serial connector being positioned proximate to and in parallel with a second edge of a circuit board that is opposite a first edge of the circuit board, which a laser diode module and a photo diode module are electrically connected to the circuit board proximate to. |

Claim Chart for Claims 166-168 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, an optical module comprising a laser diode module comprising a laser diode to produce and transmit a laser diode optical signal based on a laser diode electrical signal. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, an optical module comprising a laser diode module comprising a laser diode to produce and transmit a laser diode optical signal based on a laser diode electrical signal. |
| A6 | USP4,911,519 | A6 does not disclose, at least, an optical module comprising a single circuit board, on which a serial connector and a laser diode electrical signal converter are mounted and to which a laser diode and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, an optical module comprising a laser diode module comprising a laser diode to produce and transmit a laser diode optical signal based on a laser diode electrical signal. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, an optical module comprising a single circuit board, on which a serial connector and a laser diode electrical signal converter are mounted and to which a laser diode and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, an optical module comprising a laser diode module comprising a laser diode to produce and transmit a laser diode optical signal based on a laser diode electrical signal. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, an optical module comprising a single circuit board, on which a serial connector and a laser diode electrical signal converter are mounted and to which a laser diode and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, an optical module comprising a laser diode module comprising a laser diode to produce and transmit a laser diode optical signal based on a laser diode electrical signal. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|-------|-----------------------------------------------|
|-----|-------|-----------------------------------------------|

| | | |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, an optical module comprising a laser diode module comprising a laser diode to produce and transmit a laser diode optical signal based on a laser diode electrical signal. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, an optical module comprising a laser diode module comprising a laser diode to produce and transmit a laser diode optical signal based on a laser diode electrical signal. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, an optical module comprising a laser diode module and a photo diode module are electrically connected to a circuit board proximate to a first edge of the circuit board that is opposite a second edge of the circuit board, which a serial connector is positioned proximate to and in parallel with. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, an optical module comprising a laser diode module comprising a laser diode to produce and transmit a laser diode optical signal based on a laser diode electrical signal. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, a serial connector being positioned proximate to and in parallel with a |

| | | |
|--|--|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | second edge of a circuit board that is opposite a first edge of the circuit board, which a laser diode module and a photo diode module are electrically connected to the circuit board proximate to. |
|--|--|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|

Claim Chart for Claim 170 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| A6 | USP4,911,519 | A6 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector, a laser diode electrical signal converter and an integrated circuit are mounted and to which a laser diode module and a phone diode are electrically connected. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, an optical module comprising a single circuit board on which a serial connector, a laser diode electrical signal converter and an integrated circuit are mounted and to which a laser diode module and a phone diode are electrically connected. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector, a laser diode electrical signal converter and an integrated circuit are mounted and to which a laser diode module and a phone diode are electrically connected. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, an optical module comprising a laser diode module and a photo diode electrically connected to a circuit board proximate to a first edge of the circuit board that is opposite a second edge of the circuit board, which a serial connector is positioned proximate to. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, | |

| | | |
|----|----------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, a serial connector being positioned proximate to and in parallel with a second edge of a circuit board that is opposite a first edge of the circuit board, which a laser diode module and a photo diode module are electrically connected to the circuit board proximate to. |

Claim Chart for Claim 171 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| A6 | USP4,911,519 | A6 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector, a laser diode electrical signal converter and an integrated circuit are mounted and to which a laser diode module and a phone diode are electrically connected. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, an optical module comprising a single circuit board on which a serial connector, a laser diode electrical signal converter and an integrated circuit are mounted and to which a laser diode module and a phone diode are electrically connected. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector, a laser diode electrical signal converter and an integrated circuit are mounted and to which a laser diode module and a phone diode are electrically connected. |
| B6 | USP5,325,454 | B7 through B9 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, an optical module comprising a laser diode module and a photo diode electrically connected to a circuit board proximate to a first edge of the circuit board that is opposite a second edge of the circuit board, which a serial connector is positioned proximate to. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal, which is transmitted at a data transmission rate of 1000 Mbits/s or more. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, | |

| | | |
|----|----------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, a serial connector being positioned proximate to and in parallel with a second edge of a circuit board that is opposite a first edge of the circuit board, which a laser diode module and a photo diode module are electrically connected to the circuit board proximate to. |

Claim Chart for Claims 172-175 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, a diode electrical signal. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A6 | USP4,911,519 | A6 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, a diode electrical signal. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, a diode electrical signal. |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, an optical |

| | | |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B2 | USP5,202,943 | module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, a diode electrical signal. |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and photo diode module are electrically connected proximate to a first edge of the circuit board. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, a diode electrical signal. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, a diode electrical signal. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode |
| C2 | USP4,727,248 | |

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|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | optical signal and transmit the laser diode optical signal. |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, a diode electrical signal. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, an optical module comprising a laser diode module and a photo diode module electrically connected to a circuit board proximate to a first edge of the circuit board that is opposite a second edge of the circuit board, which a serial connector is positioned proximate to. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, a serial connector being positioned proximate to and in parallel with a second edge of a circuit board that is opposite a first edge of the circuit board, which a laser diode module and a photo diode module are electrically connected to the circuit board proximate to. |

Claim Chart for Claims 176-177 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A6 | USP4,911,519 | A6 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, an optical |

| | | |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B2 | USP5,202,943 | module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and photo diode module are electrically connected proximate to a first edge of the circuit board. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode |
| C2 | USP4,727,248 | |

| | | |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | optical signal and transmit the laser diode optical signal. |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, a plurality of pins to mount a optical module to a motherboard are fixed to a frame. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |

Claim Chart for Claims 178-179 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A6 | USP4,911,519 | A6 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, an optical |

| | | |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B2 | USP5,202,943 | module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and a photo diode module are electrically connected proximate to a first edge of the circuit board. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode |
| C2 | USP4,727,248 | |

| | | |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | optical signal and transmit the laser diode optical signal. |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, an optical module comprising a laser diode module and a photo diode module electrically connected to a circuit board proximate to a first edge of the circuit board that is opposite a second edge of the circuit board, which a serial connector is positioned proximate to. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, a serial connector being positioned proximate to and in parallel with a second edge of a circuit board that is opposite a first edge of the circuit board, which a laser diode module and a photo diode module are electrically connected to the circuit board proximate to. |

Claim Chart for Claims 180-181 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A2 | USP4,553,813 | A2 through A4 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | A5 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A6 | USP4,911,519 | A6 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and a photo diode module are electrically connected. |
| A7 | USP4,912,521 | A7 and A8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | A9 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| A10 | USP4,969,924 | A10 and A11 do not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and a photo diode module are electrically connected. |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | A12 through A16 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 and B2 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a |
| B2 | USP5,202,943 | |

| | | |
|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | serial connector, into a laser diode electrical signal. |
| B3 | USP5,243,678 | B3 and B4 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | B5 does not disclose, at least, an optical module comprising a single circuit board on which a serial connector and a laser diode electrical signal converter are mounted, and to which a laser diode module and a photo diode module are electrically connected. |
| B6 | USP5,325,454 | B6 through B10 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. |

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|-----|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D3 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | D4 does not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | D5 through D7 do not disclose, at least, an optical module comprising a laser diode module to convert a laser diode electrical signal into a laser diode optical signal and transmit the laser diode optical signal. |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | D8 does not disclose, at least, an optical module comprising a laser diode electrical signal converter to convert serial data, received from a serial connector, into a laser diode electrical signal. |

Claim Chart for Claims 182-183 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 through A16 do not disclose, at least, a module cap comprising a first cap portion and a second cap portion to protect a laser diode module and a photo |
| A2 | USP4,553,813 | |
| A3 | USP4,612,670 | |

| | | |
|-----|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A4 | USP4,625,333 | diode module of an optical module, respectively, such that the first cap portion and the second cap portion are each formed having a cavity with a projection formed therein, and into each of the cavities one of a laser diode module and a photo diode module is at least partially inserted when the module cap is attached to the optical module. |
| A5 | USP4,737,008 | |
| A6 | USP4,911,519 | |
| A7 | USP4,912,521 | |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | |
| A10 | USP4,969,924 | |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 through B10 do not disclose, at least, a module cap comprising a first cap portion and a second cap portion to protect a laser diode module and a photo diode module of an optical module, respectively, such that the first cap portion and the second cap portion are each formed having a cavity with a projection formed therein, and into each of the cavities one of a laser diode module and a photo diode module is at least partially inserted when the module cap is attached to the optical module. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | |
| B6 | USP5,325,454 | |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, a module cap comprising a first cap portion and a second cap portion to protect a laser diode module and a photo diode module of an optical module, respectively, such that the first cap portion and the second cap portion are each formed having a cavity with a projection formed therein, and into each of the cavities one of a laser diode module and a photo diode module is at least partially inserted when the module cap is attached to the optical module. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, a module cap |

| | | |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | comprising a first cap portion and a second cap portion to protect a laser diode module and a photo diode module of an optical module, respectively, such that the first cap portion and the second cap portion are each formed having a cavity with a projection formed therein, and into each of the cavities one of a laser diode module and a photo diode module is at least partially inserted when the module cap is attached to the optical module. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, a module cap comprising a first cap portion and a second cap portion to protect a laser diode module and a photo diode module of an optical module, respectively, such that the first cap portion and the second cap portion are each formed having a cavity with a projection formed therein, and into each of the cavities one of a laser diode module and a photo diode module is at least partially inserted when the module cap is attached to the optical module. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, a module cap comprising a first cap portion and a second cap portion to protect a laser diode module and a photo diode module of an optical module, respectively, such that the first cap portion and the second cap portion are each formed having a cavity with a projection formed therein, and into each of the cavities one of a laser diode module and a photo diode module is at least partially inserted when the module cap is attached to the optical module. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C9 | USP5,561,727 | |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|-------|-----------------------------------------------|
|-----|-------|-----------------------------------------------|

| | | |
|----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D8 do not disclose, at least, a module cap comprising a first cap portion and a second cap portion to protect a laser diode module and a photo diode module of an optical module, respectively, such that the first cap portion and the second cap portion are each formed having a cavity with a projection formed therein, and into each of the cavities one of a laser diode module and a photo diode module is at least partially inserted when the module cap is attached to the optical module. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | |

Claim Chart for Claim 184 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 through A16 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity, such that the module cap is formed having the laser diode cavity into which a laser diode module is at least partially inserted and the photo diode cavity into which a photo diode module is at least partially inserted. |
| A2 | USP4,553,813 | |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | |
| A6 | USP4,911,519 | |
| A7 | USP4,912,521 | |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | |
| A10 | USP4,969,924 | |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 through B10 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity, such that the module cap is formed having the laser diode cavity into which a laser diode module is at least partially inserted and the photo diode cavity into which a photo diode module is at least partially inserted. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | |
| B6 | USP5,325,454 | |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity, such that the module cap is formed having the laser diode cavity into which a laser diode module is at least partially inserted and the photo diode cavity into which a photo diode module is at least partially inserted. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. |

| | | |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| | | Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity, such that the module cap is formed having the laser diode cavity into which a laser diode module is at least partially inserted and the photo diode cavity into which a photo diode module is at least partially inserted. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity, such that the module cap is formed having the laser diode cavity into which a laser diode module is at least partially inserted and the photo diode cavity into which a photo diode module is at least partially inserted. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity, such that the module cap is formed having the laser diode cavity into which a laser diode module is at least partially inserted and the photo diode cavity into which a photo diode module is at least partially inserted. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D8 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity, such that the module cap is formed having the laser diode cavity into which a laser diode module is at least partially inserted and the photo diode cavity into which a photo diode module is at least partially inserted. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | |

Claim Chart for Claim 185 of 10/766,488

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1 | USP4,432,604 | A1 through A16 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity. |
| A2 | USP4,553,813 | |
| A3 | USP4,612,670 | |
| A4 | USP4,625,333 | |
| A5 | USP4,737,008 | |
| A6 | USP4,911,519 | |
| A7 | USP4,912,521 | |
| A8 | USP4,913,511 | |
| A9 | USP4,945,229 | |
| A10 | USP4,969,924 | |
| A11 | USP4,979,787 | |
| A12 | USP5,013,247 | |
| A13 | USP5,039,194 | |
| A14 | USP5,047,835 | |
| A15 | USP5,099,307 | |
| A16 | USP5,113,466 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| B1 | USP5,127,071 | B1 through B10 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity. |
| B2 | USP5,202,943 | |
| B3 | USP5,243,678 | |
| B4 | USP5,280,191 | |
| B5 | USP5,289,345 | |
| B6 | USP5,325,454 | |
| B7 | USP5,325,455 | |
| B8 | USP5,337,398 | |
| B9 | USP5,432,630 | |
| B10 | USP5,452,388 | |
| B11 | USP5,475,783 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B12 | USP5,515,468 | B12 and B13 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity. |
| B13 | USP5,526,160 | |
| B14 | USP5,535,034 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| B15 | USP5,550,941 | B15 does not disclose, at least, a module cap |

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| | | comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity. |
| B16 | USP5,561,727 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C1 | USP5,604,831 | C1 and C2 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity. |
| C2 | USP4,727,248 | |
| C3 | USP5,528,408 | This reference does not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C4 | USP5,276,756 | C4 through C8 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity. |
| C5 | USP5,376,182 | |
| C6 | USP5,422,972 | |
| C7 | USP5,644,668 | |
| C8 | USP5,993,074 | |
| C9 | USP5,561,727 | C9-C11 do not qualify as prior art. Applicants have claimed priority to Japanese Application No. 06-086691, filed on April 25, 1994, in Japan. |
| C10 | JP7-225327 | |
| C11 | JP7-225328 | |

| Ref | Title | Distinction between reference(s) and claim(s) |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D1 | Hewlett-Packard, Optoelectronics Designer's Catalog, 1990. | D1 through D8 do not disclose, at least, a module cap comprising a laser diode projection formed in a laser diode cavity and a photo diode projection formed in a photo diode cavity. |
| D2 | Sumitomo Electric Fiber Optics Corp., Product Bulletin, FDDI Optical Transceiver, ES-9217-XC, publication date unknown. | |
| D3 | Sumitomo Electric, Technical Specification for FDDI Optical Transceiver Module, ES-9217-XC, SC Duplex FDDI PMD, ES-9210-XC, SC Duplex LCF PMD, March 25, 1993. | |
| D4 | Proposal for Multi-Chip Integration submitted to the Advanced Research Projects Agency dated May 11, 1993, publication date unknown. | |
| D5 | Thomas & Betts, INFO-LAN Fiber Optic Map Network (IEEE 802.4) Users Manual, August 1988. | |
| D6 | IBM Opto-Electronics Enterprise, RCL-2000 LCF-PMD FDDI, Preliminary | |

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| | Specifications, Jan. 7, 1993. | |
| D7 | Hewlett-Packard, FDDI 1300nm Transceiver, Technical Data, HFBR-5125, 1991. | |
| D8 | Daniel J. Wasser, Optical Datalinks, AT&T Technical Journal, p.46-52, January/February, 1992 | |

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